



Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

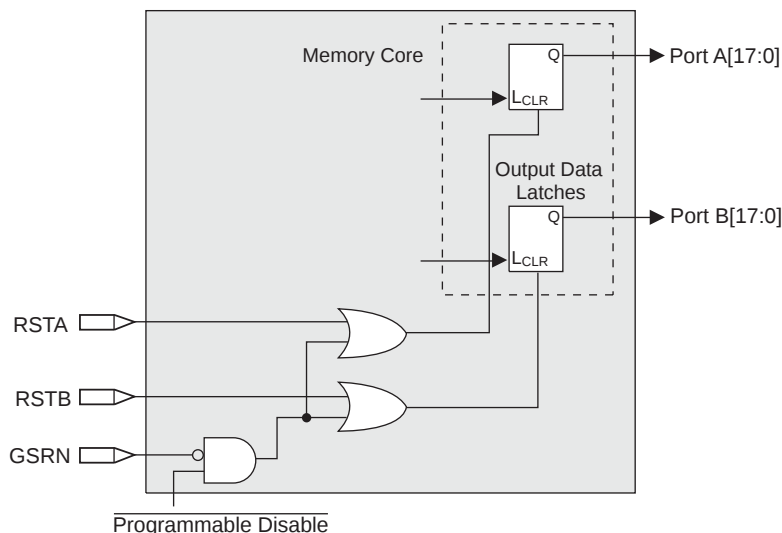
Product Status	Active
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	304
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20e-7fn484c

2. Write Through – A copy of the input data appears at the output of the same port during a write cycle. This mode is supported for all data widths.

Memory Core Reset

The memory array in the EBR utilizes latches at the A and B output ports. These latches can be reset asynchronously or synchronously. RSTA and RSTB are local signals, which reset the output latches associated with Port A and Port B, respectively. The Global Reset (GSRN) signal resets both ports. The output data latches and associated resets for both ports are as shown in Figure 2-20.

Figure 2-20. Memory Core Reset

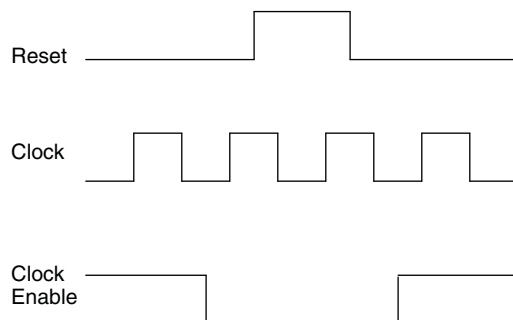


For further information about the sysMEM EBR block, please see the the list of additional technical documentation at the end of this data sheet.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-21. The GSR input to the EBR is always asynchronous.

Figure 2-21. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active.

These instructions apply to all EBR RAM and ROM implementations.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

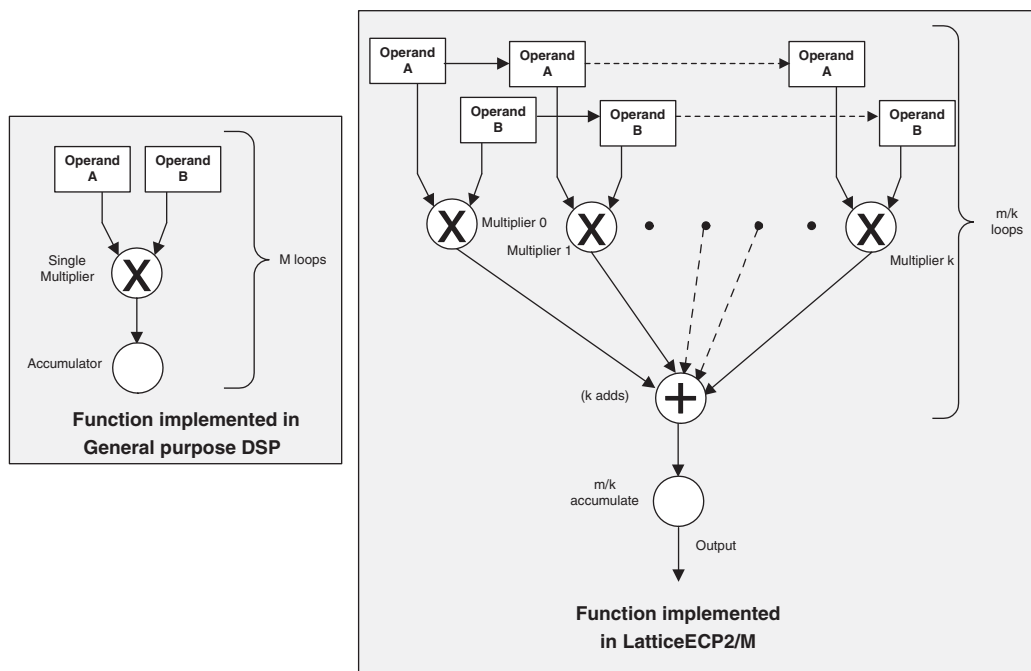
sysDSP™ Block

The LatticeECP2/M family provides a sysDSP block, making it ideally suited for low cost, high performance Digital Signal Processing (DSP) applications. Typical functions used in these applications are Finite Impulse Response (FIR) filters, Fast Fourier Transforms (FFT) functions, Correlators, Reed-Solomon/Turbo/Convolution encoders and decoders. These complex signal processing functions use similar building blocks such as multiply-adders and multiply-accumulators.

sysDSP Block Approach Compared to General DSP

Conventional general-purpose DSP chips typically contain one to four (Multiply and Accumulate) MAC units with fixed data-width multipliers; this leads to limited parallelism and limited throughput. Their throughput is increased by higher clock speeds. The LatticeECP2/M, on the other hand, has many DSP blocks that support different data-widths. This allows the designer to use highly parallel implementations of DSP functions. The designer can optimize the DSP performance vs. area by choosing an appropriate level of parallelism. Figure 2-22 compares the fully serial and the mixed parallel and serial implementations.

Figure 2-22. Comparison of General DSP and LatticeECP2/M Approaches



sysDSP Block Capabilities

The sysDSP block in the LatticeECP2/M family supports four functional elements in three 9, 18 and 36 data path widths. The user selects a function element for a DSP block and then selects the width and type (signed/unsigned) of its operands. The operands in the LatticeECP2/M family sysDSP Blocks can be either signed or unsigned but not mixed within a function element. Similarly, the operand widths cannot be mixed within a block. In the LatticeECP2/M family the DSP elements can be concatenated.

The resources in each sysDSP block can be configured to support the following elements:

- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADDSUB	4	2	—
MULTADDSUBSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

Table 2-12. PIO Signals List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block flip-flops
CLK0, CLK1	Control from the core	System clocks for input and output blocks
ECLK1, ECLK2	Control from the core	Fast edge clocks
LSR	Control from the core	Local Set/Reset
GSRN	Control from routing	Global Set/Reset (active low)
INCK ²	Input to the core	Input to Primary Clock Network or PLL reference inputs
DQS	Input to PIO	DQS signal from logic (routing) to PIO
INDD	Input to the core	Unregistered data input to core
INFF	Input to the core	Registered input on positive edge of the clock (CLK0)
IPOS0, IPOS1	Input to the core	Double data rate registered inputs to the core
QPOS0 ¹ , QPOS1 ¹	Input to the core	Gearbox pipelined inputs to the core
QNEG0 ¹ , QNEG1 ¹	Input to the core	Gearbox pipelined inputs to the core
OPOS0, ONEG0, OPOS2, ONEG2	Output data from the core	Output signals from the core for SDR and DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation
DEL[3:0]	Control from the core	Dynamic input delay control bits
TD	Tristate control from the core	Tristate signal from the core used in SDR operation
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block
DQSXFER	Control from core	Controls signal to the Output block

1. Signals available on left/right/bottom only.

2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

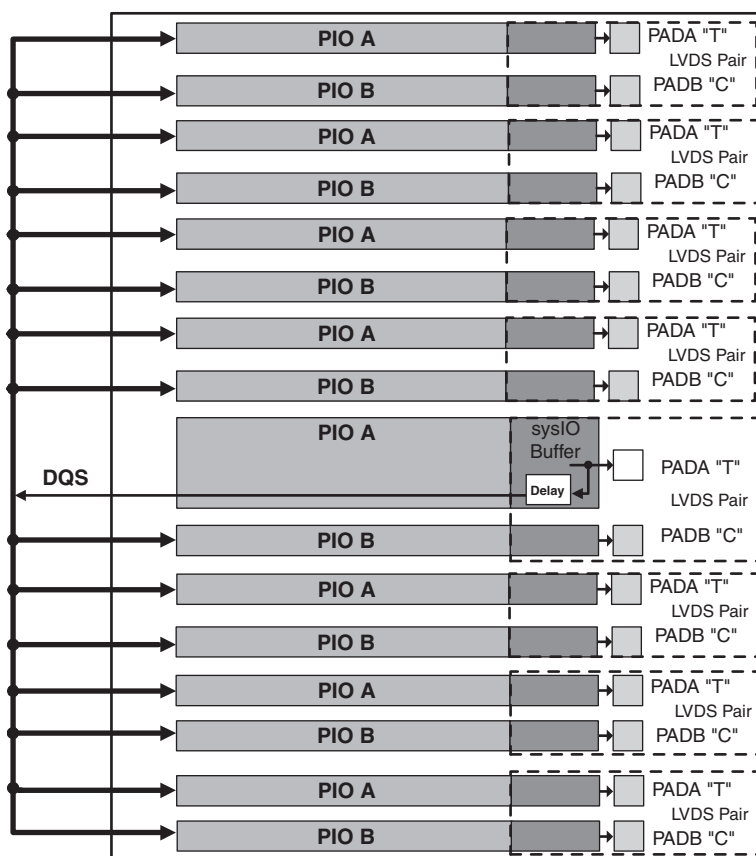
The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

Top Edge

The PICs on the top edge are different from PIOs on the left, right and bottom edges. PIOs on this edge do not have DDR registers or DQS signals.

The exact DQS pins are shown in a dual function in the Logic Signal Connections table in this data sheet. Additional detail is provided in the Signal Descriptions table. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. Interfaces on the left and right edges are designed for DDR memories that support 16 bits of data, whereas interfaces on the bottom are designed for memories that support 18 bits of data.

Figure 2-33. DQS Input Routing for the Left and Right Edges of the Device





LatticeECP2/M Family Data Sheet

DC and Switching Characteristics

September 2013

Data Sheet DS1006

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC} -0.5 to 1.32V

Supply Voltage V_{CCAUX} -0.5 to 3.75V

Supply Voltage V_{CCJ} -0.5 to 3.75V

Output Supply Voltage V_{CCIO} -0.5 to 3.75V

Input or I/O Tristate Voltage Applied⁴ -0.5 to 3.75V

Storage Temperature (Ambient) -65 to 150°C

Junction Temperature (T_j) +125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions⁷

Symbol	Parameter	Min.	Max.	Units
$V_{CC}^{1, 4, 5}$	Core Supply Voltage	1.14	1.26	V
$V_{CCAUX}^{1, 3, 4, 5}$	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage	1.14	1.26	V
$V_{CCIO}^{1, 2, 4}$	I/O Driver Supply Voltage	1.14	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	85	°C
t_{JIND}	Junction Temperature, Industrial Operation	-40	100	°C
SERDES External Power Supply (For LatticeECP2M Family Only)				
V_{CCIB}	Input Buffer Power Supply (1.2V)	1.14	1.26	V
	Input Buffer Power Supply (1.5V)	1.425	1.575	V
V_{CCOB}	Output Buffer Power Supply (1.2V)	1.14	1.26	V
	Output Buffer Power Supply (1.5V)	1.425	1.575	V
$V_{CCAUX33}$	Termination Resistor Switching Power Supply	3.135	3.465	V
V_{CCR}^6	Receive Power Supply	1.14	1.26	V
V_{CCT}^6	Transmit Power Supply	1.14	1.26	V

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{SU_DEL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.40	—	1.70	—	1.90	—	ns
		LFE2M70	1.40	—	1.70	—	1.90	—	ns
		LFE2M100	1.40	—	1.70	—	1.90	—	ns
t _{H_DEL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IO}	Clock Frequency of I/O Register and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Edge Clock without PLL)¹									
t _{COE}	Clock to Output - PIO Output Register	LFE2-6	—	2.60	—	2.90	—	3.20	ns
		LFE2-12	—	2.60	—	2.90	—	3.20	ns
		LFE2-20	—	2.60	—	2.90	—	3.20	ns
		LFE2-35	—	2.60	—	2.90	—	3.20	ns
		LFE2-50	—	2.60	—	2.90	—	3.20	ns
		LFE2-70	—	2.60	—	2.90	—	3.20	ns
		LFE2M20	—	2.60	—	2.90	—	3.20	ns
		LFE2M35	—	2.60	—	2.90	—	3.20	ns
		LFE2M50	—	3.10	—	3.40	—	3.70	ns
		LFE2M70	—	3.10	—	3.40	—	3.70	ns
		LFE2M100	—	3.10	—	3.40	—	3.70	ns

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
G17	PR13B	2	RDQ14	C	PR15B	2	RDQ16	C
F19	PR13A	2	RDQ14	T	PR15A	2	RDQ16	T
E20	PR12B	2	RDQ14	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
D20	PR12A	2	RDQ14	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
F18	PR11B	2	RDQ14	C	PR13B	2	RDQ16	C
F16	PR11A	2	RDQ14	T	PR13A	2	RDQ16	T
C21	PR10B	2	RDQ14	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
C22	PR10A	2	RDQ14	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
GNDIO	GNDIO2	-			GNDIO2	-		
D19	PR2B	2	VREF2_2/RDQ6	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2/RDQ6	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT73B	1	VREF2_1	C	PT82B	1	VREF2_1	C
GNDIO	GNDIO1	-			GNDIO1	-		
B22	PT73A	1	VREF1_1	T	PT82A	1	VREF1_1	T
C20	PT72B	1		C	PT81B	1		C
C19	PT72A	1		T	PT81A	1		T
D18	PT71B	1		C	PT80B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
E18	PT71A	1		T	PT80A	1		T
B20	PT70B	1		C	PT79B	1		C
A19	PT70A	1		T	PT79A	1		T
D17	PT69B	1		C	PT78B	1		C
C18	PT69A	1		T	PT78A	1		T
A21	PT68B	1		C	PT77B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
A20	PT68A	1		T	PT77A	1		T
A18	PT67B	1		C	PT76B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
B18	PT67A	1		T	PT76A	1		T
G16	PT66B	1		C	PT75B	1		C
G15	PT66A	1		T	PT75A	1		T
D16	PT65B	1		C	PT74B	1		C
E16	PT65A	1		T	PT74A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO	1		
C17	PT55B	1		C	PT64B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT55A	1		T	PT64A	1		T
B17	PT54B	1		C	PT63B	1		C
B16	PT54A	1		T	PT63A	1		T
A17	PT53B	1		C	PT62B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
A16	PT53A	1		T	PT62A	1		T
C15	PT52B	1		C	PT61B	1		C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7		
F4	PL2A	7	VREF2_7	T (LVDS)*
F3	PL2B	7	VREF1_7	C (LVDS)*
H4	PL3A	7		T
G5	PL3B	7		C
GND	GNDIO7	-		
D2	PL4A	7		T (LVDS)*
D1	PL4B	7		C (LVDS)*
E2	PL5A	7		T
VCCIO	VCCIO7	7		
E1	PL5B	7		C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
F1	PL14A	7	LUM1_SPLLT_IN_A/LDQ12	T (LVDS)*
F2	PL14B	7	LUM1_SPLLC_IN_A/LDQ12	C (LVDS)*
G1	PL15A	7	LUM1_SPLLT_FB_A/LDQ12	T
G2	PL15B	7	LUM1_SPLLC_FB_A/LDQ12	C
GND	GNDIO7	-		
H8	PL18A	7	LDQ21	T
H6	PL18B	7	LDQ21	C
VCCIO	VCCIO7	7		
G4	PL19A	7	LDQ21	T (LVDS)*
G3	PL19B	7	LDQ21	C (LVDS)*
H7	PL20A	7	LDQ21	T
H5	PL20B	7	LDQ21	C
GND	GNDIO7	-		
H2	PL21A	7	LDQS21	T (LVDS)*
H1	PL21B	7	LDQ21	C (LVDS)*
J6	PL22A	7	LDQ21	T
VCCIO	VCCIO7	7		
J8	PL22B	7	LDQ21	C
J2	PL23A	7	LDQ21	T (LVDS)*
J1	PL23B	7	LDQ21	C (LVDS)*
J5	PL24A	7	LDQ21	T
GND	GNDIO7	-		
J7	PL24B	7	LDQ21	C
J4	PL25A	7	LDQ29	T (LVDS)*
J3	PL25B	7	LDQ29	C (LVDS)*
K6	PL26A	7	LDQ29	T
K8	PL26B	7	LDQ29	C
VCCIO	VCCIO7	7		
K2	PL27A	7	LDQ29	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG4	NC	-		
AG8	NC	-		
AH1	NC	-		
AH16	NC	-		
AH2	NC	-		
AH26	NC	-		
AH27	NC	-		
AH29	NC	-		
AH30	NC	-		
AH4	NC	-		
AJ1	NC	-		
AJ2	NC	-		
AJ27	NC	-		
AJ28	NC	-		
AJ29	NC	-		
AJ3	NC	-		
AJ30	NC	-		
AK2	NC	-		
AK27	NC	-		
AK28	NC	-		
AK29	NC	-		
AK3	NC	-		
B1	NC	-		
B2	NC	-		
B3	NC	-		
B30	NC	-		
B4	NC	-		
B5	NC	-		
C1	NC	-		
C2	NC	-		
C29	NC	-		
C30	NC	-		
C4	NC	-		
D13	NC	-		
D18	NC	-		
D23	NC	-		
D28	NC	-		
D29	NC	-		
D3	NC	-		
D30	NC	-		
D4	NC	-		
E25	NC	-		
E26	NC	-		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
E13	PT28B	1		C	PT46B	1		C	
D12	PT28A	1		T	PT46A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
A9	PT27B	1		C	PT45B	1		C	
A8	PT27A	1		T	PT45A	1		T	
A7	PT26B	1		C	PT44B	1		C	
A6	PT26A	1		T	PT44A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
E12	PT25B	1		C	PT43B	1		C	
F12	PT25A	1		T	PT43A	1		T	
A5	PT24B	1		C	PT42B	1		C	
A4	PT24A	1		T	PT42A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
B7	PT23B	1		C	PT41B	1		C	
B8	PT23A	1		T	PT41A	1		T	
G11	PT22B	1		C	PT40B	1		C	
E11	PT22A	1		T	PT40A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
D11	PT21B	1	VREF2_1	C	PT39B	1	VREF2_1	C	
D10	PT21A	1	VREF1_1	T	PT39A	1	VREF1_1	T	
F11	PT20A	1	PCLKT1_0	T	PT38A	1	PCLKT1_0	T	
G10	PT20B	1	PCLKC1_0	C	PT38B	1	PCLKC1_0	C	
G9	PT19B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
F9	PT19A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
C9	PT18B	0	VREF2_0	C	PT36B	0	VREF2_0	C	
D9	PT18A	0	VREF1_0	T	PT36A	0	VREF1_0	T	
A2	PT17B	0		C	PT35B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
A3	PT17A	0		T	PT35A	0		T	
B3	PT16B	0		C	PT34B	0		C	
C4	PT16A	0		T	PT34A	0		T	
E10	PT15B	0		C	PT33B	0		C	
F10	PT15A	0		T	PT33A	0		T	
C7	PT14B	0		C	PT32B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
B6	PT14A	0		T	PT32A	0		T	
C6	PT13B	0		C	PT31B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
C5	PT13A	0		T	PT31A	0		T	
C8	PT12B	0		C	PT30B	0		C	
D8	PT12A	0		T	PT30A	0		T	
E8	PT11B	0		C	PT29B	0		C	
E9	PT11A	0		T	PT29A	0		T	
-	-	-			GNDIO0	-			
-	-	-			VCCIO0	0			
F8	PT10B	0		C	PT10B	0		C	
G8	PT10A	0		T	PT10A	0		T	

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO7	-		
L1	PL36A	7	LDQS36	T (LVDS)*
L2	PL36B	7	LDQ36	C (LVDS)*
M7	PL37A	7	LDQ36	T
VCCIO	VCCIO7	7		
L5	PL37B	7	LDQ36	C
L3	PL38A	7	LDQ36	T (LVDS)*
L4	PL38B	7	LDQ36	C (LVDS)*
M1	PL39A	7	PCLKT7_0/LDQ36	T
GNDIO	GNDIO7	-		
M2	PL39B	7	PCLKC7_0/LDQ36	C
M6	PL41A	6	PCLKT6_0	T (LVDS)*
M5	PL41B	6	PCLKC6_0	C (LVDS)*
M3	PL42A	6	VREF2_6	T
M4	PL42B	6	VREF1_6	C
VCCIO	VCCIO6	6		
N7	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO6	-		
N6	PL45B	6	LLM3_SPLLC_IN_A	C (LVDS)*
N1	PL46A	6	LLM3_SPLLT_FB_A	T
N2	PL46B	6	LLM3_SPLLC_FB_A	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
P6	PL52A	6	LDQS52****	T (LVDS)*
N5	PL52B	6	LDQ52	C (LVDS)*
P1	PL53A	6	LDQ52	T
VCCIO	VCCIO6	6		
P2	PL53B	6	LDQ52	C
P3	PL54A	6	LDQ52	T (LVDS)*
P4	PL54B	6	LDQ52	C (LVDS)*
P5	PL55A	6	LDQ52	T
GNDIO	GNDIO6	-		
P7	PL55B	6	LDQ52	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
R1	PL62A	6	LLM0_GPLLT_IN_A**	T (LVDS)*
GNDIO	GNDIO6	-		
R2	PL62B	6	LLM0_GPLLC_IN_A**	C (LVDS)*
R3	PL63A	6	LLM0_GPLLT_FB_A	T
R4	PL63B	6	LLM0_GPLLC_FB_A	C
VCCIO	VCCIO6	6		
R6	PL64A	6	LLM0_GDLLT_IN_A**	T (LVDS)*
R5	PL64B	6	LLM0_GDLLC_IN_A**	C (LVDS)*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P8	PL45A	6	LDQ48	T	PL49A	6	LDQ52	T	
R6	PL45B	6	LDQ48	C	PL49B	6	LDQ52	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T1	PL46A	6	LDQ48	T (LVDS)*	PL50A	6	LDQ52	T*	
U1	PL46B	6	LDQ48	C (LVDS)*	PL50B	6	LDQ52	C*	
R7	PL47A	6	LDQ48	T	PL51A	6	LDQ52	T	
T5	PL47B	6	LDQ48	C	PL51B	6	LDQ52	C	
GNDIO	GNDIO6	-			GNDIO6	-			
U3	PL48A	6	LDQS48	T (LVDS)*	PL52A	6	LDQS52	T*	
U4	PL48B	6	LDQ48	C (LVDS)*	PL52B	6	LDQ52	C*	
U5	PL49A	6	LDQ48	T	PL53A	6	LDQ52	T	
VCCIO	VCCIO6	6			VCCIO6	6			
U6	PL49B	6	LDQ48	C	PL53B	6	LDQ52	C	
U2	PL50A	6	LDQ48	T (LVDS)*	PL54A	6	LDQ52	T*	
V1	PL50B	6	LDQ48	C (LVDS)*	PL54B	6	LDQ52	C*	
W2	PL51A	6	LDQ48	T	PL55A	6	LDQ52	T	
GNDIO	GNDIO6	-			GNDIO6	-			
V2	PL51B	6	LDQ48	C	PL55B	6	LDQ52	C	
V4	PL55A	6	LDQ57	T (LVDS)*	PL59A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL55B	6	LDQ57	C (LVDS)*	PL59B	6		C*	
-	-	-			GNDIO6	-			
W4	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57****	T (LVDS)*	PL62A	6	LLM0_GPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
W3	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	PL62B	6	LLM0_GPLLC_IN_A	C*	
W1	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T	PL63A	6	LLM0_GPLLT_FB_A	T	
Y1	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	PL63B	6	LLM0_GPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
AA1	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*	PL64A	6	LLM0_GDLLT_IN_A	T*	
AB1	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	PL64B	6	LLM0_GDLLC_IN_A	C*	
U7	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T	PL65A	6	LLM0_GDLLT_FB_A	T	
V6	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	PL65B	6	LLM0_GDLLC_FB_A	C	
GNDIO	GNDIO6	-			GNDIO6	-			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
W5	PL62A	6	LDQ66	T (LVDS)*	PL67A	6	LDQ71	T*	
Y4	PL62B	6	LDQ66	C (LVDS)*	PL67B	6	LDQ71	C*	
U8	PL63A	6	LDQ66	T	PL68A	6	LDQ71	T	
W6	PL63B	6	LDQ66	C	PL68B	6	LDQ71	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y3	PL64A	6	LDQ66	T (LVDS)*	PL69A	6	LDQ71	T*	
AA3	PL64B	6	LDQ66	C (LVDS)*	PL69B	6	LDQ71	C*	
V7	NC	-			PL70A	6	LDQ71	T	
Y5	PL65B	6	LDQ66	C	PL70B	6	LDQ71	C	
GNDIO	GNDIO6	-			GNDIO6	-			
AB2	PL66A	6	LDQS66	T (LVDS)*	PL71A	6	LDQS71	T*	
AA4	PL66B	6	LDQ66	C (LVDS)*	PL71B	6	LDQ71	C*	
Y6	PL67A	6	LDQ66	T	PL72A	6	LDQ71	T	
VCCIO	VCCIO6	6			VCCIO6	6			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF4	PB17B	5	BDQ15	C	PB17B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AF5	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
AF6	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
Y12	PB19A	5	BDQ15	T	PB19A	5	BDQ15	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AB11	PB19B	5	BDQ15	C	PB19B	5	BDQ15	C	
-	-	-			VCCIO5	5			
-	-	-			GNDIO5	-			
AD7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T	
AF7	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C	
AD8	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T	
AA12	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C	
AE8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AF8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C	
AD9	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T	
AC10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C	
AC11	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AB12	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C	
AD10	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T	
Y13	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C	
AF9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AE9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C	
AF10	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T	
AE10	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C	
AD11	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AF11	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AA13	PB33A	5	BDQS33****	T	PB42A	5	BDQS42****	T	
AB13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C	
W14	PB34A	5	VREF2_5/BDQ33	T	PB43A	5	VREF2_5/BDQ42	T	
AC12	PB34B	5	VREF1_5/BDQ33	C	PB43B	5	VREF1_5/BDQ42	C	
AF12	PB35A	5	PCLKT5_0/BDQ33	T	PB44A	5	PCLKT5_0/BDQ42	T	
AD12	PB35B	5	PCLKC5_0/BDQ33	C	PB44B	5	PCLKC5_0/BDQ42	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AC13	PB40A	4	PCLKT4_0/BDQ42	T	PB49A	4	PCLKT4_0/BDQ51	T	
VCCIO	VCCIO4	4			VCCIO4	4			
Y14	PB40B	4	PCLKC4_0/BDQ42	C	PB49B	4	PCLKC4_0/BDQ51	C	
AB20	PB57A	4	BDQ60	T	PB50A	4	VREF2_4/BDQ51	T	
AC14	PB41B	4	VREF1_4/BDQ42	C	PB50B	4	VREF1_4/BDQ51	C	
AB14	PB42A	4	BDQS42****	T	PB51A	4	BDQS51****	T	
GNDIO	GNDIO4	-			GNDIO4	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AJ17	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AF26	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T	
AE25	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD24	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T	
AE24	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C	
AD18	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T	
AC18	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C	
AE18	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T	
AG19	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
AC19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T	
AD20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C	
AB18	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T	
AC20	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C	
AE20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T	
AE21	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AC23	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T	
AD23	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AH18	LRC_SQ_VCCR3	13			LRC_SQ_VCCR3	13			
AK19	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T	
AJ18	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13			
AJ19	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C	
AH21	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13			
AK22	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T	
AK21	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13			
AJ22	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C	
AH22	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13			
AJ23	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C	
AH23	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13			
AK23	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T	
AH19	LRC_SQ_VCCR2	13			LRC_SQ_VCCR2	13			
AJ20	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C	
AH20	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13			
AK20	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T	
AH24	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13			
AG24	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T	
AF24	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C	
AJ24	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13			
AK28	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T	
AH28	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13			
AJ28	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C	
AH29	LRC_SQ_VCCR1	13			LRC_SQ_VCCR1	13			
AK25	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L13	VCC	-			VCC	-			
L18	VCC	-			VCC	-			
L19	VCC	-			VCC	-			
M11	VCC	-			VCC	-			
M12	VCC	-			VCC	-			
M13	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M15	VCC	-			VCC	-			
M16	VCC	-			VCC	-			
M17	VCC	-			VCC	-			
M18	VCC	-			VCC	-			
M19	VCC	-			VCC	-			
M20	VCC	-			VCC	-			
N11	VCC	-			VCC	-			
N12	VCC	-			VCC	-			
N19	VCC	-			VCC	-			
N20	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P19	VCC	-			VCC	-			
R12	VCC	-			VCC	-			
R19	VCC	-			VCC	-			
T12	VCC	-			VCC	-			
T19	VCC	-			VCC	-			
U12	VCC	-			VCC	-			
U19	VCC	-			VCC	-			
V11	VCC	-			VCC	-			
V12	VCC	-			VCC	-			
V19	VCC	-			VCC	-			
V20	VCC	-			VCC	-			
W11	VCC	-			VCC	-			
W12	VCC	-			VCC	-			
W13	VCC	-			VCC	-			
W14	VCC	-			VCC	-			
W15	VCC	-			VCC	-			
W16	VCC	-			VCC	-			
W17	VCC	-			VCC	-			
W18	VCC	-			VCC	-			
W19	VCC	-			VCC	-			
W20	VCC	-			VCC	-			
Y12	VCC	-			VCC	-			
Y13	VCC	-			VCC	-			
Y18	VCC	-			VCC	-			
Y19	VCC	-			VCC	-			
D14	VCCIO0	0			VCCIO0	0			
E6	VCCIO0	0			VCCIO0	0			
E9	VCCIO0	0			VCCIO0	0			
F12	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	0			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y15	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
AA26	NC	-			NC	-		
AB10	PL73B	6	LDQ71	C (LVDS)*	NC	-		
AB11	NC	-			NC	-		
AB12	NC	-			NC	-		
AB13	NC	-			NC	-		
AB14	NC	-			NC	-		
AB15	NC	-			NC	-		
AB16	NC	-			NC	-		
AB17	NC	-			NC	-		
AB19	NC	-			NC	-		
AB20	NC	-			NC	-		
AB21	NC	-			NC	-		
AB9	PL73A	6	LDQ71	T (LVDS)*	NC	-		
AC10	PL74B	6	LDQ71	C	NC	-		
AC11	NC	-			NC	-		
AC21	NC	-			NC	-		
AC22	NC	-			NC	-		
AC8	PL70B	6	LDQ71	C	NC	-		
AC9	PL74A	6	LDQ71	T	NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD4	PL68A	6	LDQ71	T	NC	-		
AD5	PL68B	6	LDQ71	C	NC	-		
AD6	PL71A	6	LDQS71	T (LVDS)*	NC	-		
AD7	PL72A	6	LDQ71	T	NC	-		
AD8	PL72B	6	LDQ71	C	NC	-		
AE23	NC	-			NC	-		
AE5	PL69A	6	LDQ71	T (LVDS)*	NC	-		
AE6	PL70A	6	LDQ71	T	NC	-		
AE7	PL71B	6	LDQ71	C (LVDS)*	NC	-		
AF20	NC	-			NC	-		
AF23	NC	-			NC	-		
AF5	PL69B	6	LDQ71	C (LVDS)*	NC	-		
AG23	NC	-			NC	-		
AG26	NC	-			NC	-		
D10	PT10A	0		T	NC	-		
E10	PT9B	0		C	NC	-		
E11	PT10B	0		C	NC	-		
F10	PT9A	0		T	NC	-		
F20	NC	-			NC	-		
F23	NC	-			NC	-		
F8	PL6B	7	LDQ6	C (LVDS)*	NC	-		
G10	NC	-			NC	-		
G20	NC	-			NC	-		
G21	NC	-			NC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M23	GND	-		
M8	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N27	GND	-		
N4	GND	-		
P11	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P20	GND	-		
R10	GND	-		
R11	GND	-		
R13	GND	-		
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R20	GND	-		
R21	GND	-		
R24	GND	-		
R7	GND	-		
T10	GND	-		
T11	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T20	GND	-		
T21	GND	-		
T24	GND	-		
T7	GND	-		
U11	GND	-		
U13	GND	-		
U14	GND	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5FN1152I	520	1.2V	-5	Lead-Free fpBGA	1152	Ind	100
LFE2M100E-6FN1152I	520	1.2V	-6	Lead-Free fpBGA	1152	Ind	100
LFE2M100E-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	100
LFE2M100E-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	100

LatticeECP2M S-Series Devices, Conventional Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5F484C	304	1.2V	-5	fpBGA	484	Com	20
LFE2M20SE-6F484C	304	1.2V	-6	fpBGA	484	Com	20
LFE2M20SE-7F484C	304	1.2V	-7	fpBGA	484	Com	20
LFE2M20SE-5F256C	140	1.2V	-5	fpBGA	256	Com	20
LFE2M20SE-6F256C	140	1.2V	-6	fpBGA	256	Com	20
LFE2M20SE-7F256C	140	1.2V	-7	fpBGA	256	Com	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5F672C	410	1.2V	-5	fpBGA	672	Com	35
LFE2M35SE-6F672C	410	1.2V	-6	fpBGA	672	Com	35
LFE2M35SE-7F672C	410	1.2V	-7	fpBGA	672	Com	35
LFE2M35SE-5F484C	303	1.2V	-5	fpBGA	484	Com	35
LFE2M35SE-6F484C	303	1.2V	-6	fpBGA	484	Com	35
LFE2M35SE-7F484C	303	1.2V	-7	fpBGA	484	Com	35
LFE2M35SE-5F256C	140	1.2V	-5	fpBGA	256	Com	35
LFE2M35SE-6F256C	140	1.2V	-6	fpBGA	256	Com	35
LFE2M35SE-7F256C	140	1.2V	-7	fpBGA	256	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5F900C	410	1.2V	-5	fpBGA	900	Com	50
LFE2M50SE-6F900C	410	1.2V	-6	fpBGA	900	Com	50
LFE2M50SE-7F900C	410	1.2V	-7	fpBGA	900	Com	50
LFE2M50SE-5F672C	372	1.2V	-5	fpBGA	672	Com	50
LFE2M50SE-6F672C	372	1.2V	-6	fpBGA	672	Com	50
LFE2M50SE-7F672C	372	1.2V	-7	fpBGA	672	Com	50
LFE2M50SE-5F484C	270	1.2V	-5	fpBGA	484	Com	50
LFE2M50SE-6F484C	270	1.2V	-6	fpBGA	484	Com	50
LFE2M50SE-7F484C	270	1.2V	-7	fpBGA	484	Com	50

Date	Version	Section	Change Summary
August 2006 (cont.)	01.1 (cont.)	Pinout Information (cont.)	Added Information on: Available Device Resources per Packaged Device table.
		Ordering Information	Updated ordering part number table to include ECP2-12.
			Updated topside mark drawing.
September 2006	02.0	Multiple	Added information regarding LatticeECP2M support throughout.
September 2006	02.1	DC and Switching Characteristics	Added Receiver Total Jitter Tolerance Specification table.
			Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table.
December 2006	02.2	Introduction	LatticeECP2M Selection Guide table has been updated.
		Architecture	Figure 2-16. Per Region Secondary Clock Selection has been updated.
			Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated.
		DC and Switching	Footnotes have been added to Recommended Operating Conditions.
			DC Electrical Characteristics table has been updated.
			Supply Current (Standby) tables have been updated.
			Initialization Supply Current table have been updated.
			Updated timing numbers to include LFE2-12E (rev A 0.08).
		Pinout Information	Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E.
		Ordering Information	Updated to include the entire ECP2 and ECP2M device ordering information.
February 2007	02.3	Architecture	Updated EBR Asynchronous Reset section.
March 2007	02.4	DC and Switching Characteristics	Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz.
March 2007	02.5	Introduction	Added "Security Series" to the LatticeECP2 and LatticeECP2M families.
		Architecture	Enhanced Configuration Option section updated.
		DC and Switching	Recommended Operating Conditions table - footnote 4 updated.
		Ordering Information	"Security Series" ordering part numbers added.
April 2007	02.6	Introduction	LatticeECP2M family table has been updated for user I/O counts.
		Ordering Information	LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100.
July 2007	02.7	Architecture	Updated text in Ripple Mode section.
		DC and Switching	ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated.
		Pinout Information	Added LatticeECP2M20 pinout information.
August 2007	02.8	Introduction	1156-fpBGA package option has been removed from the LatticeECP2M family.
		Architecture	Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated.
		DC and Switching	Supply Current (Standby) table has been updated.
			DSP Function timing has been updated.